Reduced Twisted Pair Gigabit Ethernet EMC & Noise Ad Hoc Report

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EMC-Noise Ad Hoc Status (11/12/2013)

Overview

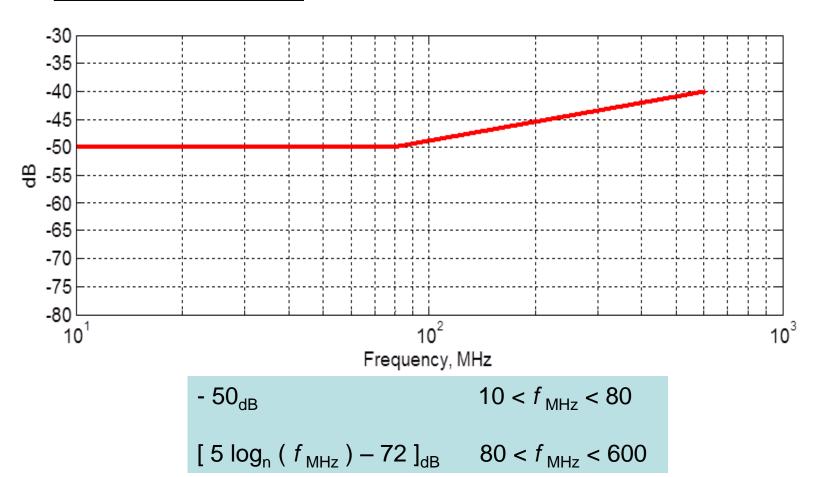
- System EMC Testing (as previously proposed)
 - Stripline for emissions testing (using 2m 1-pair UTP cable)
 - BCI for immunity testing (using 2m 1-pair UTP cable)
- So far,
 - The EMC requirements were provided by OEMs and Tier1s
 - Egress & Ingress modeling were provided for EMC analysis yielding to a component level mode conversion limit line.
 - There has been a lot of inputs & contributions showing that the proposed component limit line is feasible for the RTPGE cables and connectors.
 - 4 different connector companies confirmed that the proposed mode conversion limit line is attainable for component level for their connectors.
 - We have two different 1-pair UTP cables which meet the component level mode conversion limit line.
- The analysis & test results were provided yielding to a baseline proposal for mode conversion of the RTPGE 15m link segment

EMC Ad Hoc Status (11/12/2013)

- Since York, we had two conference calls (10/18/2013 & 11/05/2013)
 - Delphi showed the RTPGE link segments based on FlexRay cabling do not meet the limit line.
 - TE showed their balance results for their RTPGE connector meeting the proposed mode conversion limit line.
 - Marvell shared results showing higher noise for their EMC testing.
 - Commscope proposed a set-up and measurement method to provide consistency for RTPGE cabling testing. The documentation was provided as an input to the standard.
 - Stefan conducted a questionnaire for the existing BCI requirements and provided the input for the EMC Ad Hoc.
- Our goal in this meeting is to adopt the baseline proposal for mode conversion parameter of RTPGE link segment in order to finish the RTPGE 15m channel definition

Baseline Proposal for Mode Conversion

• The <u>mode conversion limit line</u> is proposed for a <u>15m UTP link segment</u> with 4-inline connectors



Previous Work Summary

Mehmet Tazebay, Broadcom Corporation Stefan Buntz, Daimler AG

RTPGE EMC & Noise Ad Hoc

- Chartered during September 2012 meeting to develop EMC & Noise models and measurements
- Conference calls & meetings held in 11/07/2012, 12/17/2012, 01/25/2013, 3/4/2013, 3/20/2013, 4/30/2013, 5/8/2013, 6/26/2013, 7/16/2013, 8/20/2013, 8/29/2013, 09/03/2013, 10/18/2013, 11/05/2013
- Communications via RTPGE/802.3bp reflector. Minutes & contributions were sent to the reflector
- Thanks to those who attended the ad hoc calls

Work-plan Summary

First Phase (Data Collection as of 7/14/2013)

- Ingress modeling
 - Define the noise sources (in-car background noise, alien XTALK, EMC noise, impulse noise, battery noise, etc.)
 - Need input for in-car broadband noise
 - Define the channel transfer function/measurement modeling methodology
- Egress modeling
 - Block diagram for PHY emissions
 - Balance measurements of the proposed RTPGE channels were provided
 - Define emissions' mask
 - Define mode conversion limit line
 - Mode conversion data for connectors was provided on 7/16.

Work-plan Summary (cntd.)

Second Phase ← We are here

- Reach consensus on a baseline limit for EM emissions (emissions' mask) and based on that define the Transmit PSD mask
- Reach consensus for mode conversion limit line
- Build consensus of all discrete noise sources and background noise

Third Phase

Develop text for standard

Overview

- Differential Channel Impairments
- EMC Noise & Limit Lines
- EMC Channel Transfer Function Modeling
- Alien XTALK
- In-Car Background Noise
- Impulse Noise
- Other Noise sources?

Differential Channel Impairments

- Insertion Loss (aka channel attenuation) varies as a function of length, frequency and temperature.
- Return Loss needs to be properly constrained for FDX systems and can have a direct impact on input dynamic range.
- Both of these impairments can be handled by digital equalization and echo cancellation.
- Status: Channel Ad-Hoc made progress for defining the differential parameters.

EMC Modeling & Limit Lines

- Stefan Buntz (Daimler) proposed DPI technique for component level emission & immunity testing (similar to IEC 62132-4) and provided the limit lines in http://grouper.ieee.org/groups/802/3/RTPGE/public/nov12/buntz_01_1112_rtpge.pdf
- CISPR 25 also addresses Conducted and Radiated Emissions' measurement techniques. If CISPR 25 is preferred method of testing then, Limit lines (dBuV vs. frequency [0.1MHz–1GHz])
- ISO 11452-2/4/5 define Radiated Immunity via Antenna, BCI and Strip Line measurement techniques. If they are preferred method of testing then, Limit lines (dBm vs. frequency [0.1MHz–1GHz])

EMC Channel Transfer Function

- CM-to-CM and CM-to-DM conversion transfer functions must be attained for RTPGE channels in order to compute the input-referred noise for the PHY.
- Mehmet Tazebay (Broadcom), Richard Mei (Commscope), Thomas Muller (Rosenberger) made proposals for method and techniques for attaining these transfer functions http://www.ieee802.org/3/bp/public/jan13/mei_3bp_01_0113.pdf
 http://www.ieee802.org/3/bp/public/jan13/mueller_3bp_01_0113.pdf
- In principle, 3-port network analyzer measurements can be used to analyze the mode conversion transfer functions.
 - http://www.ieee802.org/3/bp/public/may13/tazebay_3bp_01_0513.pdf

Alien XTALK modeling

Kirsten Matheus (BMW) proposed a few select cable bundle topologies based on use cases agreed-upon by participating OEMs:

http://www.ieee802.org/3/bp/public/jan13/matheus_3bp_02_0113.pdf

- Several measurements were made based on the presented topologies (Mei et al, Commscope and Donahue & Estes, UNH) using UTP channels
 - http://www.ieee802.org/3/bp/public/jan13/mei_3bp_01_0113.pdf http://www.ieee802.org/3/bp/public/jul13/donahue_3bp_01_0713.pdf
- Preliminary results indicate that alien XTALK is within the limit lines for the select cables. More test results are expected with the final channel parameters.

In-Car Background Noise

- Stefan Buntz (Daimler) provided a direct measurement technique and results for BG in the car http://www.ieee802.org/3/bp/public/mar13/buntz_3bp_01_0313.pdf
- The background noise was measured as common mode noise (dBuV versus frequency [0.1MHz-1GHz]).
- The EMC channel transfer functions dictate the inputreferred common mode and differential mode noise observed by the PHY.

In-Car Impulse Noise

- ISO 7637-2 lists tests for transient immunity testing (pulses 1-5) for supply lines
 - Is RTPGE with PoE expected to pass these immunity pulses?
 - Are there additional requirements in excess of ISO 7637-2?
 - What criteria is considered passing for this test?
 - Class A requires a BW of the pulse within the PSD of RTPGE!
- □ <u>ISO 7637-3</u> lists tests for transient immunity testing for signal lines.
 - Is RTPGE MDI expected to pass these immunity transient test pulses?
 - Are there additional requirements in excess of ISO 7637-3?
 - What criteria is considered passing for this test? Is it different from the ISO 7637-3 standard?
- Thomas Hogenmuller (Bosch) made a contribution showing empirical, simulation and emulation results for in-car impulse noise. This work extensively provides information for the impulse-noise model. The mathematical parameters are provided by Mr. Hogenmuller. http://www.ieee802.org/3/bp/public/jul13/jul13.htm

Other Noise Sources

- Battery Noise, PoDL considerations and etc.
- A contribution was made by Yair Darshan (Microsemi) which discussed the noise sources over a single data & power pair http://ieee802.org/3/bp/public/may13/darshan_3bp_01_0513.pdf
- What else are we missing?

Summary

- Progress for the link segment parameters (channel ad hoc)
 - IL, RL, Alien XTALK
- EMC-Noise Ad Hoc gathered large amount of information for
 - Emissions & Immunity for 1-pair UTP cables
 - Transmit PSD
 - Mode conversion limit line
 - Impulse Noise measurements & modeling were presented for automotive environment
 - Battery Noise effect was discussed
 - The effects of temperature on the IL & RL discussed in this meeting.
 - The effects of MDI connectors for EMC performance were discussed in Geneva meeting.
 - The effects of inline connectors for EMC performance will be presented in this meeting.
- Now, based on the data that we have it is time to reach consensus on the TX PSD and mode conversion parameters so that we can start evaluating the baseline proposals.
- Questions?